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Fairchild Semiconductor FDA28N50F

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May 2014



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### FDA28N50F

# N-Channel UniFET<sup>TM</sup> FRFET<sup>®</sup> MOSFET 500 V, 28 A, 175 m $\Omega$

#### **Features**

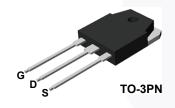
- $R_{DS(on)}$  = 140 m $\Omega$  (Typ.) @  $V_{GS}$  = 10 V,  $I_D$  = 14 A
- Low Gate Charge (Typ. 80 nC)
- Low C<sub>rss</sub> (Typ. 38 pF)
- · 100% Avalanche Tested
- · Improved dv/dt Capability
- · RoHS Compliant

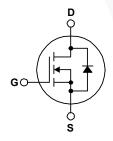
#### **Applications**

- PDP TV
- · Uninterruptible Power Supply
- · AC-DC Power Supply

### **Description**

UniFET<sup>TM</sup> MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. The body diode's reverse recovery performance of UniFET FRFET® MOSFET has been enhanced by lifetime control. Its trr is less than 100nsec and the reverse dv/dt immunity is 15V/ns while normal planar MOSFETs have over 200nsec and 4.5V/nsec respectively. Therefore, it can remove additional component and improve system reliability in certain applications in which the performance of MOSFET's body diode is significant. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts





#### **MOSFET Maximum Ratings** T<sub>C</sub> = 25°C unless otherwise noted.

Symbol		Parameter		FDA28N50F	Unit
V <sub>DSS</sub>	Drain to Source Voltage			500	V
V <sub>GSS</sub>	Gate to Source Voltage		-	±30	V
	Drain Current	- Continuous (T <sub>C</sub> = 25°C)		28	Α
ID	Drain Current	- Continuous (T <sub>C</sub> = 100°C)		17	A
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	112	Α
E <sub>AS</sub>	Single Pulsed Avalanche E	nergy	(Note 2)	2352	mJ
I <sub>AR</sub>	Avalanche Current		(Note 1)	28	Α
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		(Note 1)	31	mJ
dv/dt	Peak Diode Recovery dv/c	t	(Note 3)	20	V/ns
D	Dower Discinction	(T <sub>C</sub> = 25°C)		310	W
P <sub>D</sub> Power Dissipation	- Derate Above 25°C		2.5	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Ter	nperature Range		-55 to +150	°C
TL	Maximum Lead Temperatu	ire for Soldering, 1/8" from Case for 5	Seconds	300	°C

#### Thermal Characteristics

Symbol	Parameter FDA28		Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.4	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max. 40		-0/00



Datasheet of FDA28N50F - MOSFET N-CH 500V 28A TO-3PN

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### **Package Marking and Ordering Information**

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FDA28N50F	FDA28N50F	TO-3PN	Tube	N/A	N/A	30 units

### **Electrical Characteristics** $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V, T_J = 25^{\circ} C$	500	-	-	V
ΔBV <sub>DSS</sub> / ΔΤ <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 μA, Referenced to 25°C	-	0.7	-	V/°C
1	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 500 V, V <sub>GS</sub> = 0 V	-	-	1	^
IDSS	Zero Gate voltage Drain Current	$V_{DS} = 400 \text{ V}, T_{C} = 125^{\circ}\text{C}$	-	-	10	μΑ
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	±100	nA

#### On Characteristics

V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	3.0	-	5.0	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 14 A	-	0.140	0.175	Ω
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 14 A	-	35	-	S

#### **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V 05 V V 0 V	-	3975	5387	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz		566	753	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 1 1011 12	-\	38	56	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10V	V <sub>DS</sub> = 400 V, I <sub>D</sub> = 28 A,	- \	80	105	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	V <sub>GS</sub> = 10 V	-	22	-	nC
$Q_{gd}$	Gate to Drain "Miller" Charge	(Note 4	-	31	-	nC

#### **Switching Characteristics**

t <sub>d(on)</sub>	Turn-On Delay Time		-	67	145	ns
t <sub>r</sub>		$V_{DD} = 250 \text{ V}, I_D = 28 \text{ A},$	-	137	285	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS}$ = 10 V, $R_G$ = 25 $\Omega$	-	192	395	ns
t <sub>f</sub>	Turn-Off Fall Time	(Note 4)	-	101	212	ns

#### **Drain-Source Diode Characteristics**

I <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current		/-	-	28	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		/ -	-	112	Α
$V_{SD}$	Drain to Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 28 A	-	-	1.5	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 28 A,	-	266	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$dI_F/dt = 100 A/\mu s$	-	1.38	/ -	μС

- 1. Repetitive rating: pulse-width limited by maximum junction temperature.
- 2. L = 6 mH, I $_{AS}$  = 28 A, V $_{DD}$  = 50 V, R $_{G}$  = 25  $\Omega$ , starting T $_{J}$  = 25°C.
- 3. I  $_{SD}$   $\leq$  28 A, di/dt  $\leq$  200 A/ $\mu$ s, V  $_{DD}$   $\leq$  BV  $_{DSS}$ , starting T  $_{J}$  = 25°C.
- 4. Essentially independent of operating temperature typical characteristics.

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## **Typical Performance Characteristics**

Figure 1. On-Region Characteristics

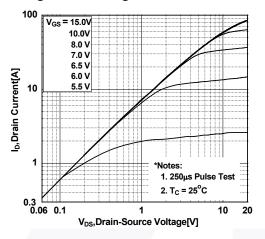


Figure 3. On-Resistance Variation vs. **Drain Current and Gate Voltage** 

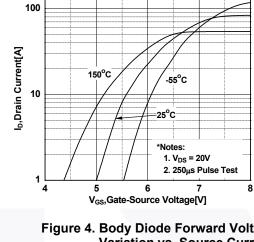
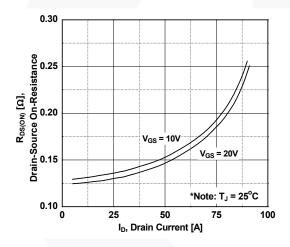
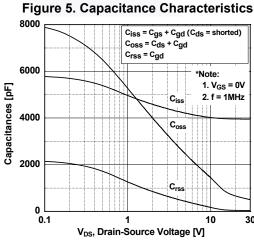


Figure 2. Transfer Characteristics

Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature





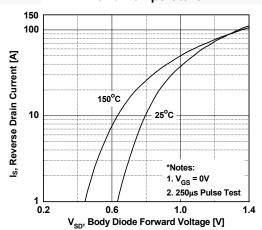
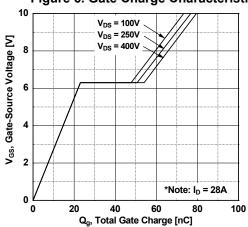


Figure 6. Gate Charge Characteristics





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#### **Typical Performance Characteristics** (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

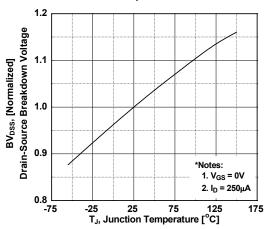


Figure 8. On-Resistance Variation vs. Temperature

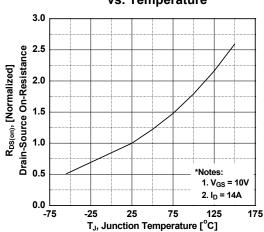


Figure 9. Maximum Safe Operating Area

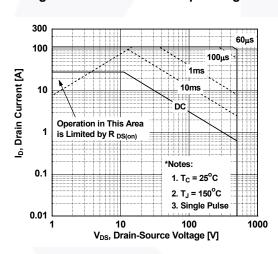


Figure 10. Maximum Drain Current vs. Case Temperature

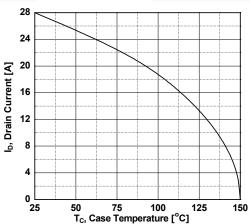
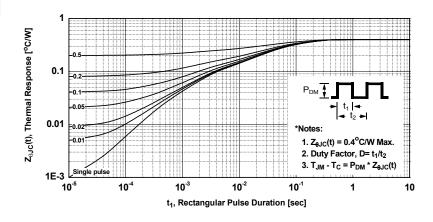


Figure 11. Transient Thermal Response Curve





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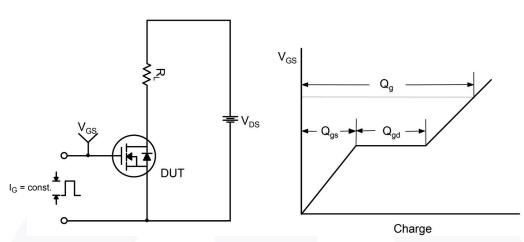


Figure 12. Gate Charge Test Circuit & Waveform

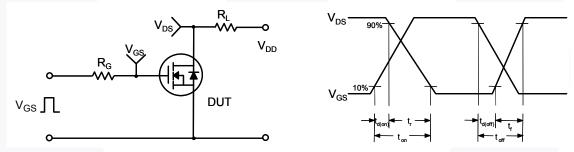


Figure 13. Resistive Switching Test Circuit & Waveforms

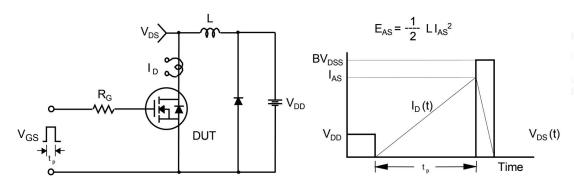
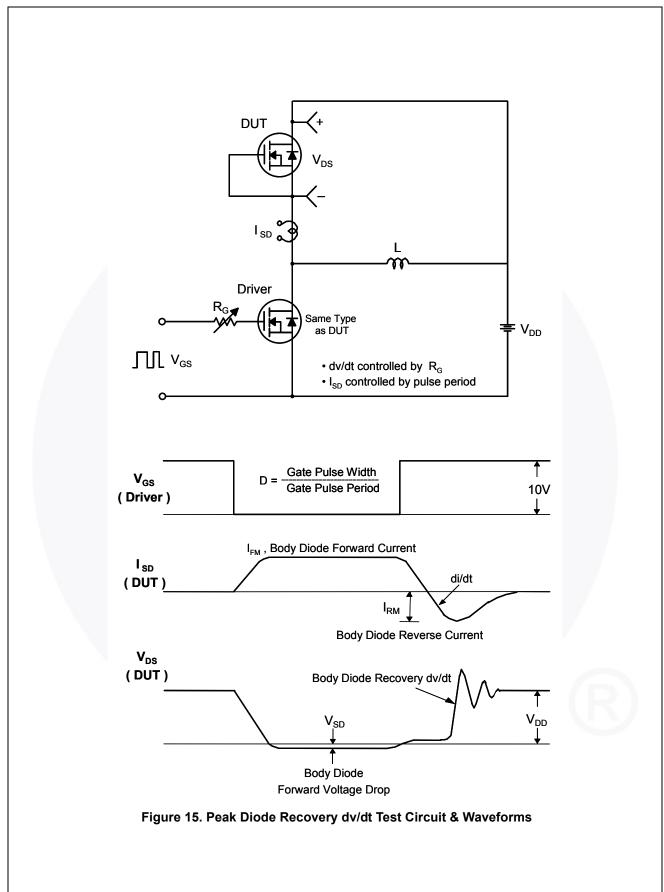


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

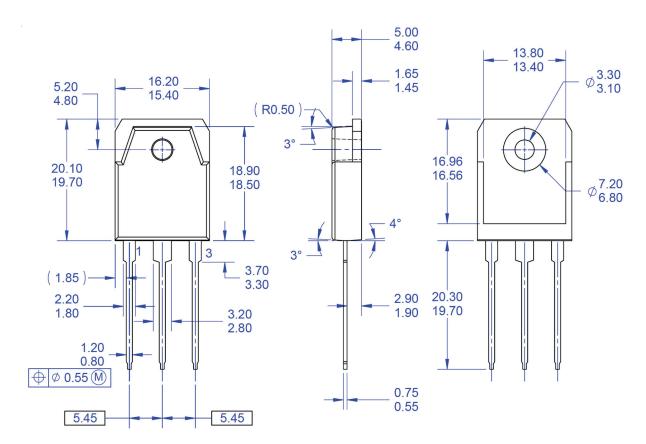


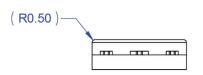
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#### **Mechanical Dimensions**





- NOTES: UNLESS OTHERWISE SPECIFIED
- A) THIS PACKAGE CONFORMS TO EIAJ SC-65 PACKAGING STANDARD.
   B) ALL DIMENSIONS ARE IN MILLIMETERS.
- DIMENSION AND TOLERANCING PER ASME14.5-2009.
- DIMENSIONS ARE EXCLUSSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSSIONS. DRAWING FILE NAME: TO3PN03AREV1. FAIRCHILD SEMICONDUCTOR.

#### Figure 16. TO3PN, 3-Lead, Plastic, EIAJ SC-65

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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
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		Rev. I68